# SiS890ADN

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Vishay Siliconix

RoHS COMPLIANT

HALOGEN

FREE



**PRODUCT SUMMARY** V<sub>DS</sub> (V) 100 0.0255  $R_{DS(on)}$  max. ( $\Omega$ ) at  $V_{GS}$  = 10 V 0.0290  $R_{DS(on)}$  max. ( $\Omega$ ) at  $V_{GS}$  = 4.5 V Q<sub>q</sub> typ. (nC) 8.8 24.7 I<sub>D</sub> (A) Configuration Single

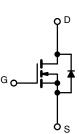
#### **FEATURES**

N-Channel 100 V (D-S) MOSFET

- TrenchFET<sup>®</sup> Gen IV power MOSFET
- Very low R<sub>DS</sub> x Q<sub>g</sub> figure-of-merit (FOM)
- Tuned for the lowest R<sub>DS</sub> x Q<sub>oss</sub> FOM
- 100 % R<sub>q</sub> and UIS tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

#### **APPLICATIONS**

- Synchronous rectification
- · Primary side switch
- DC/DC converter
- · Motor drive switch
- Circuit protection
- Load switch



| ORDERING INFORMATION            |                  |
|---------------------------------|------------------|
| Package                         | PowerPAK 1212-8  |
| Lead (Pb)-free and halogen-free | SiS890ADN-T1-GE3 |

| ABSOLUTE MAXIMUM RATING                                   | $\mathbf{U}_{(1A} = 25 \ 0, t$ | 1                                 |                     |      |  |
|---|--------------------------------|-----------------------------------|---------------------|------|--|
| PARAMETER   |                                | SYMBOL                            | LIMIT               | UNIT |  |
| Drain-source voltage                                      |                                | V <sub>DS</sub>                   | 100                 | V    |  |
| Gate-source voltage                                       |                                | V <sub>GS</sub>                   | ± 20                | v    |  |
|   | T <sub>C</sub> = 25 °C         |                                   | 24.7                |      |  |
| Continuous drain current ( $T_J = 150 \ ^{\circ}C$ )      | T <sub>C</sub> = 70 °C         | 1 . F                             | 19.8                |      |  |
|   | T <sub>A</sub> = 25 °C         |                                   | 7.6 <sup>b, c</sup> |      |  |
|   | T <sub>A</sub> = 70 °C         | 1 [                               | 6.0 <sup>b, c</sup> | A    |  |
| Pulsed drain current (t = 100 µs)                         |                                | I <sub>DM</sub>                   | 40                  | A    |  |
| Continuous source-drain diode current                     | T <sub>C</sub> = 25 °C         |                                   | 35.4                |      |  |
| Continuous source-drain diode current                     | T <sub>A</sub> = 25 °C         | I <sub>S</sub>                    | 3.2 <sup>b, c</sup> |      |  |
| Single pulse avalanche current                            | L = 0.1 mH                     | I <sub>AS</sub>                   | 12                  |      |  |
| Single pulse avalanche energy                             | L = 0.1 mH                     | E <sub>AS</sub>                   | 7.2                 | mJ   |  |
|   | T <sub>C</sub> = 25 °C         |                                   | 39                  |      |  |
| Maximum neuror discinction                                | T <sub>C</sub> = 70 °C         |                                   | 25                  | w    |  |
| Maximum power dissipation                                 | T <sub>A</sub> = 25 °C         | PD                                | 3.6 <sup>b, c</sup> | VV   |  |
|   | T <sub>A</sub> = 70 °C         | 1 [                               | 2.4 <sup>b, c</sup> |      |  |
| Operating junction and storage temperature range          |                                | T <sub>J</sub> , T <sub>stg</sub> | -55 to +150         | **   |  |
| Soldering recommendations (peak temperature) <sup>c</sup> |                                |                                   | 260                 |      |  |

#### THERMAL RESISTANCE RATINGS

| PARAMETER                                |              | SYMBOL            | TYPICAL | MAXIMUM | UNIT |
|--|--------------|-------------------|---------|---------|------|
| Maximum junction-to-ambient <sup>b</sup> | t ≤ 10 s     | R <sub>thJA</sub> | 26      | 34      | °C/W |
| Maximum junction-to-case (drain)         | Steady state | R <sub>thJC</sub> | 2.4     | 3.2     | C/W  |

#### Notes

a. Package limited
b. Surface mounted on 1" x 1" FR4 board
c. t = 10 s

e. f.

 $T_{\rm C} = 25 \,^{\circ}{\rm C}$ g.

S20-0559-Rev. A, 20-Jul-2020

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See solder profile (<u>www.vishay.com/doc?73257</u>). The PowerPAK 1212-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection Rework conditions: manual soldering with a soldering iron is not recommended for leadless components Maximum under steady state conditions is 81 °C/W d.

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# SiS890ADN

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| PARAMETER                                     | SYMBOL                  | TEST CONDITIONS  | MIN. | TYP.   | MAX.   | UNIT  |
|---|-------------------------|--|------|--------|--------|-------|
| Static  |                         |  | •    |        |        |       |
| Drain-source breakdown voltage                | V <sub>DS</sub>         | $V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$  | 100  | -      | -      | V     |
| V <sub>DS</sub> temperature coefficient       | $\Delta V_{DS}/T_{J}$   | I <sub>D</sub> = 10 mA   | -    | 85     | -      |       |
| V <sub>GS(th)</sub> temperature coefficient   | $\Delta V_{GS(th)}/T_J$ | I <sub>D</sub> = 250 μA  | -    | -4.5   | -      | mV/°C |
| Gate-source threshold voltage                 | V <sub>GS(th)</sub>     | $V_{DS} = V_{GS}$ , $I_D = 250 \ \mu A$  | 1    | -      | 2.5    | V     |
| Gate-source leakage                           | I <sub>GSS</sub>        | $V_{DS} = 0 V, V_{GS} = \pm 20 V$  | -    | -      | 100    | nA    |
| Zara gata valtaga drain avreat                |                         | $V_{DS} = 100 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$   | -    | -      | 1      |       |
| Zero gate voltage drain current               | IDSS                    | $V_{DS}$ = 100 V, $V_{GS}$ = 0 V, $T_{J}$ = 70 °C  | -    | -      | 15     | μA    |
| On-state drain current <sup>a</sup>           | I <sub>D(on)</sub>      | $V_{DS} \geq 10 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$  | 20   | -      | -      | Α     |
|   | D                       | $V_{GS} = 10 \text{ V}, \text{ I}_{D} = 10 \text{ A}$  | -    | 0.0210 | 0.0255 |       |
| Drain-source on-state resistance <sup>a</sup> | R <sub>DS(on)</sub>     | $V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 10 \text{ A}$   | -    | 0.0240 | 0.0290 | Ω     |
| Forward transconductance <sup>a</sup>         | 9 <sub>fs</sub>         | $V_{DS} = 15 \text{ V}, \text{ I}_{D} = 10 \text{ A}$  | -    | 49     | -      | S     |
| Dynamic <sup>b</sup>                          |                         |  |      | •      |        |       |
| Input capacitance                             | C <sub>iss</sub>        |  | -    | 1330   | -      | pF    |
| Output capacitance                            | C <sub>oss</sub>        | $V_{DS} = 50 \text{ V}, V_{GS} = 0 \text{ V}, \text{ f} = 1 \text{ MHz}$                           | -    | 69     | -      |       |
| Reverse transfer capacitance                  | C <sub>rss</sub>        |  | -    | 7.2    | -      |       |
| Total acto charge                             |                         | $V_{DS} = 50 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 10 \text{ A}$                                 | -    | 19.2   | 29     |       |
| Total gate charge                             | Qg                      |  | -    | 8.8    | 14     |       |
| Gate-source charge                            | Q <sub>gs</sub>         | $V_{DS} = 50 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 10 \text{ A}$                                | -    | 4.3    | -      | nC    |
| Gate-drain charge                             | Q <sub>gd</sub>         |  | -    | 2.1    | -      |       |
| Output charge                                 | Q <sub>oss</sub>        | $V_{DS} = 50 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$  | -    | 13.6   | -      |       |
| Gate resistance                               | Rg                      | f = 1 MHz  | 0.3  | 0.87   | 1.5    | Ω     |
| Turn-on delay time                            | t <sub>d(on)</sub>      |  | -    | 9      | 18     |       |
| Rise time                                     | t <sub>r</sub>          | $V_{DD} = 50 \text{ V}, \text{ R}_{\text{I}} = 5 \Omega, \text{ I}_{\text{D}} \cong 10 \text{ A},$ | -    | 6      | 12     |       |
| Turn-off delay time                           | t <sub>d(off)</sub>     | $V_{\text{GEN}} = 10 \text{ V}, \text{ R}_{\text{g}} = 1 \Omega$                                   | -    | 19     | 38     |       |
| Fall time                                     | t <sub>f</sub>          |  | -    | 4      | 8      |       |
| Turn-on delay time                            | t <sub>d(on)</sub>      |  | -    | 14     | 28     | ns    |
| Rise time                                     | tr                      | $V_{DD} = 50 \text{ V}, \text{ R}_{\text{I}} = 5 \Omega, \text{ I}_{\text{D}} \cong 10 \text{ A},$ | -    | 8      | 16     | -     |
| Turn-off delay time                           | t <sub>d(off)</sub>     | $V_{\text{GEN}} = 4.5 \text{ V}, \text{ R}_{\text{g}} = 1 \Omega$                                  | -    | 15     | 30     |       |
| Fall time                                     | t <sub>f</sub>          |  | -    | 5      | 10     |       |
| Drain-Source Body Diode Characteristi         | cs                      |  |      |        |        |       |
| Continuous source-drain diode current         | I <sub>S</sub>          | T <sub>C</sub> = 25 °C   | -    | -      | 35.4   |       |
| Pulse diode forward current                   | I <sub>SM</sub>         |  | -    | -      | 40     | A     |
| Body diode voltage                            | V <sub>SD</sub>         | I <sub>S</sub> = 5 A, V <sub>GS</sub> = 0 V  | -    | 0.78   | 1.1    | V     |
| Body diode reverse recovery time              | t <sub>rr</sub>         |  | -    | 29     | 58     | ns    |
| Body diode reverse recovery charge            | Q <sub>rr</sub>         | I <sub>F</sub> = 10 A, di/dt = 100 A/μs,   | -    | 39     | 78     | nC    |
| Reverse recovery fall time                    | t <sub>a</sub>          | $T_{\rm J} = 25 ^{\circ}{\rm C}$   | -    | 25     | -      |       |
| Reverse recovery rise time                    | t <sub>b</sub>          | -  | -    | 4      |        | ns    |

#### Notes

a. Pulse test; pulse width  $\leq 300~\mu\text{s},$  duty cycle  $\leq 2~\%$ 

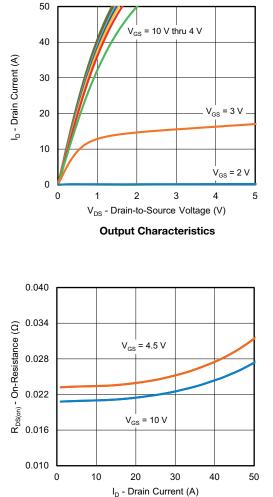
b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

2

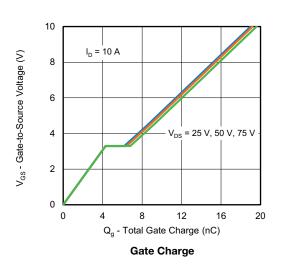


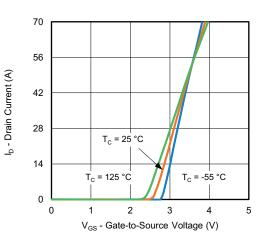
## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



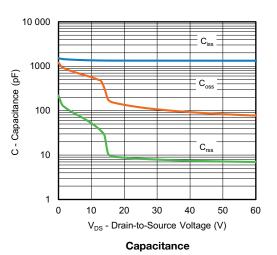
I<sub>D</sub> - Drain Current (A)

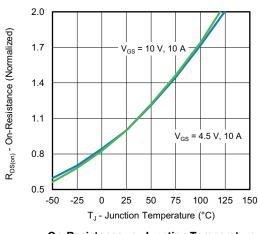
**On-Resistance vs. Drain Current and Gate Voltage** 





**Transfer Characteristics** 





**On-Resistance vs. Junction Temperature** 

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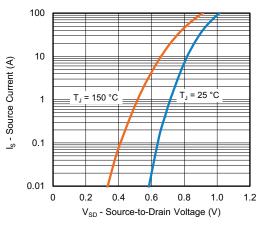
3

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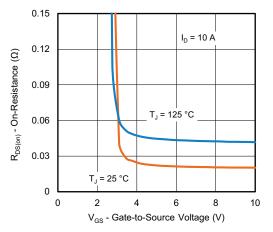
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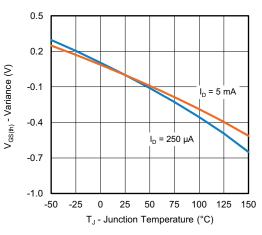
## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



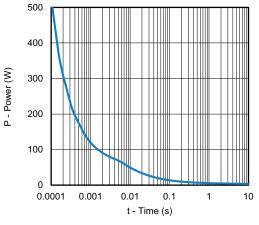
Source-Drain Diode Forward Voltage



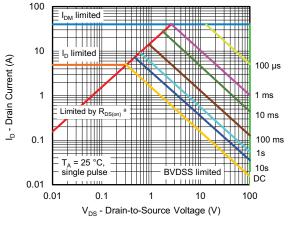
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage



Single Pulse Power, Junction-to-Ambient



Safe Operating Area, Junction-to-Ambient

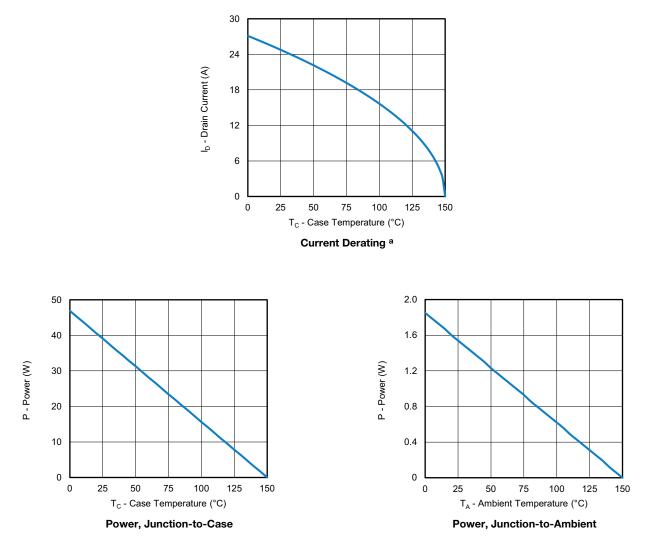
#### Note

a.  $V_{GS}$  > minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified

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### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

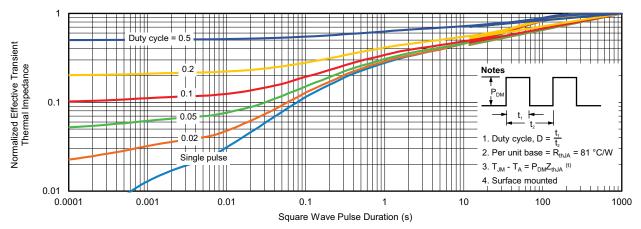


#### Note

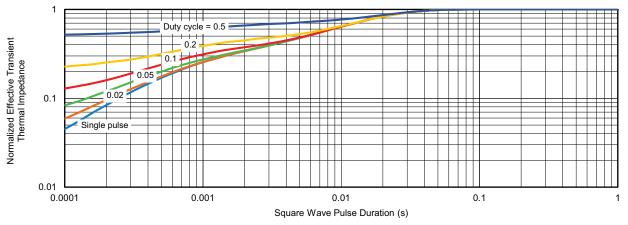
a. The power dissipation P<sub>D</sub> is based on T<sub>J</sub> max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



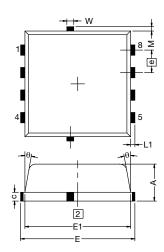
Normalized Thermal Transient Impedance, Junction-to-Case

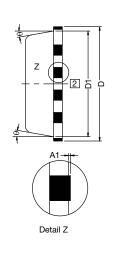
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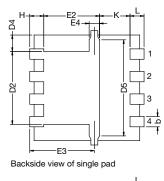


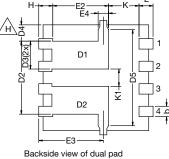
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# PowerPAK® 1212-8, (Single / Dual)









Notes

1. Inch will govern

Dimensions exclusive of mold gate burrs
Dimensions exclusive of mold flash and cutting burrs

| DIM.                      | MILLIMETERS      |             |      | INCHES     |            |       |  |
|---------------------------|------------------|-------------|------|------------|------------|-------|--|
| DIM.                      | MIN.             | NOM.        | MAX. | MIN.       | NOM.       | MAX.  |  |
| А                         | 0.97             | 1.04        | 1.12 | 0.038      | 0.041      | 0.044 |  |
| A1                        | 0.00             | -           | 0.05 | 0.000      | -          | 0.002 |  |
| b                         | 0.23             | 0.30        | 0.41 | 0.009      | 0.012      | 0.016 |  |
| С                         | 0.23             | 0.28        | 0.33 | 0.009      | 0.011      | 0.013 |  |
| D                         | 3.20             | 3.30        | 3.40 | 0.126      | 0.130      | 0.134 |  |
| D1                        | 2.95             | 3.05        | 3.15 | 0.116      | 0.120      | 0.124 |  |
| D2                        | 1.98             | 2.11        | 2.24 | 0.078      | 0.083      | 0.088 |  |
| D3                        | 0.48             | -           | 0.89 | 0.019      | -          | 0.035 |  |
| D4                        | 0.47 typ.        |             |      |            | 0.0185 typ |       |  |
| D5                        |                  | 2.3 typ. 0. |      |            | 0.090 typ  |       |  |
| E                         | 3.20             | 3.30        | 3.40 | 0.126      | 0.130      | 0.134 |  |
| E1                        | 2.95             | 3.05        | 3.15 | 0.116      | 0.120      | 0.124 |  |
| E2                        | 1.47             | 1.60        | 1.73 | 0.058      | 0.063      | 0.068 |  |
| E3                        | 1.75             | 1.85        | 1.98 | 0.069      | 0.073      | 0.078 |  |
| E4                        |                  | 0.034 typ.  |      | 0.013 typ. |            |       |  |
| е                         |                  | 0.65 BSC    |      | 0.026 BSC  |            |       |  |
| К                         |                  | 0.86 typ.   |      | 0.034 typ. |            |       |  |
| K1                        | 0.35             | -           | -    | 0.014      | -          | -     |  |
| Н                         | 0.30             | 0.41        | 0.51 | 0.012      | 0.016      | 0.020 |  |
| L                         | 0.30             | 0.43        | 0.56 | 0.012      | 0.017      | 0.022 |  |
| L1                        | 0.06             | 0.13        | 0.20 | 0.002      | 0.005      | 0.008 |  |
| θ                         | 0°               | -           | 12°  | 0°         | -          | 12°   |  |
| W                         | 0.15             | 0.25        | 0.36 | 0.006      | 0.010      | 0.014 |  |
| М                         | 0.125 typ.       |             |      | 0.005 typ. |            |       |  |
| N: S16-2667-R<br>/G: 5882 | ev. M, 09-Jan-17 |             |      |            |            |       |  |

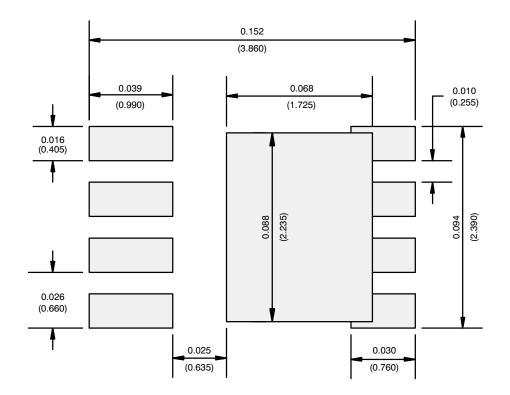
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# RECOMMENDED MINIMUM PADS FOR PowerPAK<sup>®</sup> 1212-8 Single



Recommended Minimum Pads Dimensions in Inches/(mm)

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